

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3	conditioning and apparatus and wire and bonder and support and boss and cavity	US-PGPUB; USPAT	OR	ON	2006/02/14 16:22
L2	61	conditioning and apparatus and support and boss and cavity and chip	US-PGPUB; USPAT	OR	ON	2006/02/14 16:26
L3	4649	conditioning and apparatus and support and chip	US-PGPUB; USPAT	OR	ON	2006/02/14 16:27
L4	2261	conditioning and wire and apparatus and support and chip	US-PGPUB; USPAT	OR	ON	2006/02/14 16:59
L5	0	boss and wire and bond and support and chip and capillary	US-PGPUB; USPAT	OR	ON	2006/02/14 17:02
L6	391	boss and wire and bond and support and chip	US-PGPUB; USPAT	OR	ON	2006/02/14 17:02

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L2	61	conditioning and apparatus and support and boss and cavity and chip	US-PGPUB; USPAT	OR	ON	2006/02/14 16:23

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